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# **FS50KM-2**

High-Speed Switching Use Nch Power MOS FET

REJ03G1418-0200 (Previous: MEJ02G0103-0101)

Rev.2.00

Aug 07, 2006

### **Features**

Drive voltage : 10 V
 V<sub>DSS</sub> : 100 V

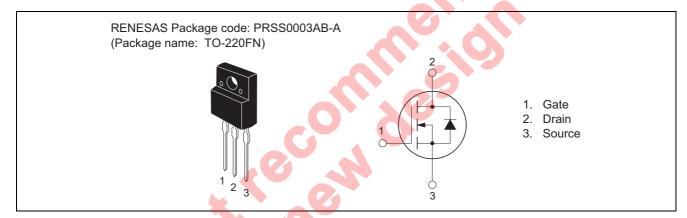
•  $r_{DS(ON) (max)}$ : 55 m $\Omega$ 

• I<sub>D</sub>: 50 A

• Integrated Fast Recovery Diode (TYP.): 105 ns

• Viso: 2000 V

### **Outline**



## **Applications**

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

## **Maximum Ratings**

 $(Tc = 25^{\circ}C)$ 

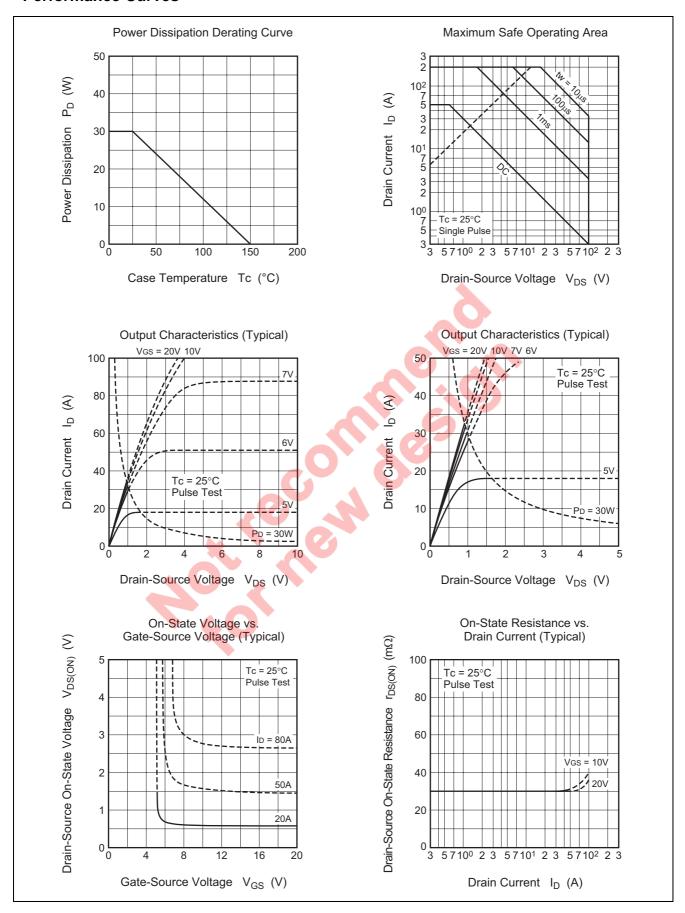
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	V <sub>DSS</sub>	100	V	V <sub>GS</sub> = 0 V
Gate-source voltage	V <sub>GSS</sub>	±20	V	$V_{DS} = 0 V$
Drain current	I <sub>D</sub>	50	А	
Drain current (Pulsed)	I <sub>DM</sub>	200	А	
Avalanche drain current (Pulsed)	I <sub>DA</sub>	50	А	L = 50 μH
Source current	Is	50	А	
Source current (Pulsed)	I <sub>SM</sub>	200	А	
Maximum power dissipation	P <sub>D</sub>	30	W	
Channel temperature	Tch	- 55 to +150	°C	
Storage temperature	Tstg	- 55 to +150	°C	
Isolation voltage	Viso	2000	V	AC for 1 minute,
				Terminal to case
Mass	_	2.0	g	Typical value

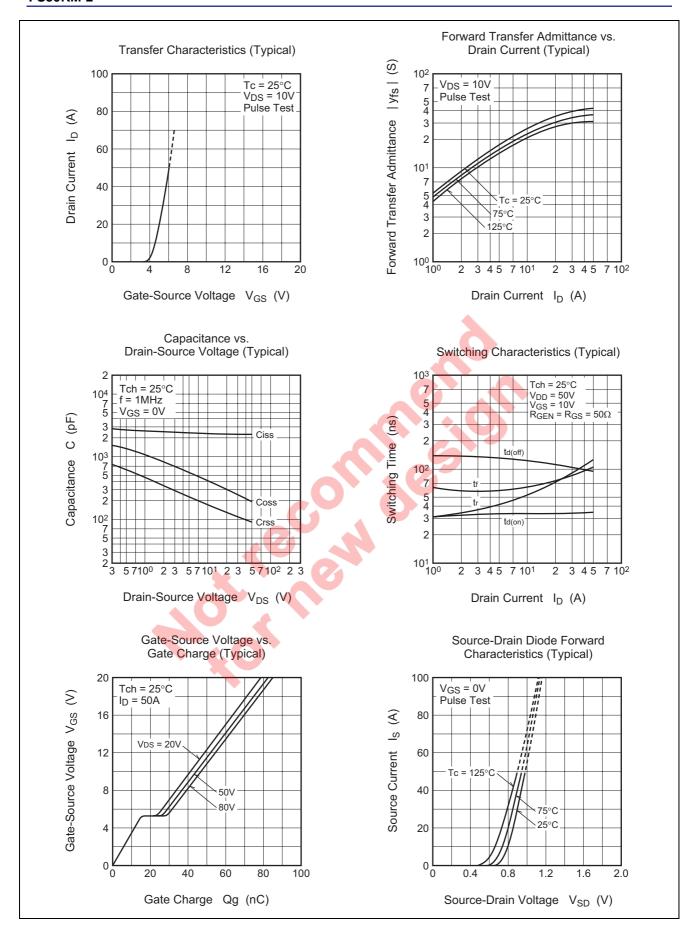
## **Electrical Characteristics**

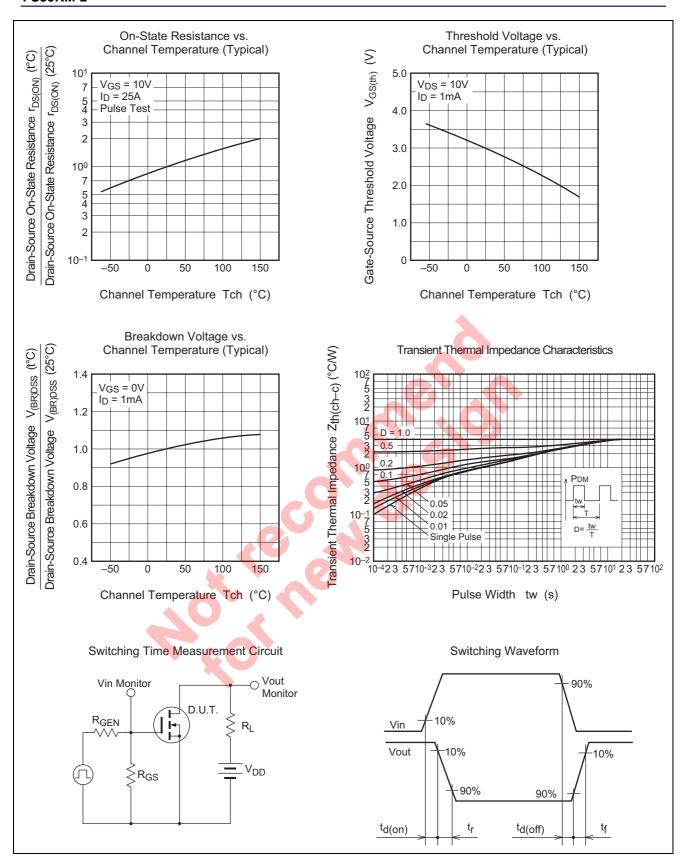
 $(Tch = 25^{\circ}C)$ 

Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	_	_	V	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	
Gate-source leakage current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Drain-source leakage current	I <sub>DSS</sub>	_	_	0.1	mA	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	
Gate-source threshold voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V	
Drain-source on-state resistance	r <sub>DS(ON)</sub>	_	39	55	mΩ	I <sub>D</sub> = 25 A, V <sub>GS</sub> = 10 V	
Drain-source on-state voltage	V <sub>DS(ON)</sub>	_	0.98	1.38	V	I <sub>D</sub> = 25 A, V <sub>GS</sub> = 10 V	
Forward transfer admittance	y <sub>fs</sub>	_	33	_	S	I <sub>D</sub> = 25 A, V <sub>DS</sub> = 10 V	
Input capacitance	Ciss	_	2300	_	pF	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V,	
Output capacitance	Coss	_	410	_	pF	f = 1MHz	
Reverse transfer capacitance	Crss	_	185	_	pF		
Turn-on delay time	t <sub>d(on)</sub>	_	35	_	ns	$V_{DD} = 50 \text{ V}, I_D = 25 \text{ A},$	
Rise time	t <sub>r</sub>	_	86	_	ns	V <sub>GS</sub> = 10 V,	
Turn-off delay time	t <sub>d(off)</sub>	_	100	_	ns	$R_{GEN} = R_{GS} = 50 \Omega$	
Fall time	t <sub>f</sub>	_	80	_	ns		
Source-drain voltage	V <sub>SD</sub>	_	1.0	1.5	V	I <sub>S</sub> = 25 A, V <sub>GS</sub> = 0 V	
Thermal resistance	R <sub>th(ch-c)</sub>	_	_	4.17	°C/W	Channel to case	
Reverse recovery time	t <sub>rr</sub>	_	105		ns	$I_S = 50 \text{ A}, d_{is}/d_t = -100 \text{ A}/\mu \text{s}$	
,							

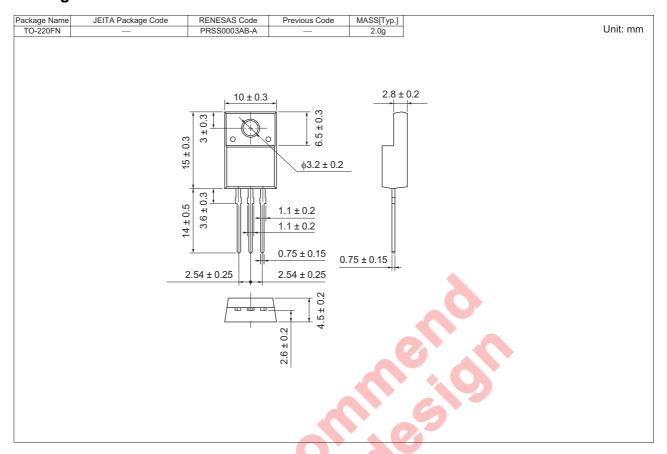
## **Performance Curves**







## **Package Dimensions**



## **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	FS50KM-2
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	FS50KM-2-A8

Note: Please confirm the specification about the shipping in detail.

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